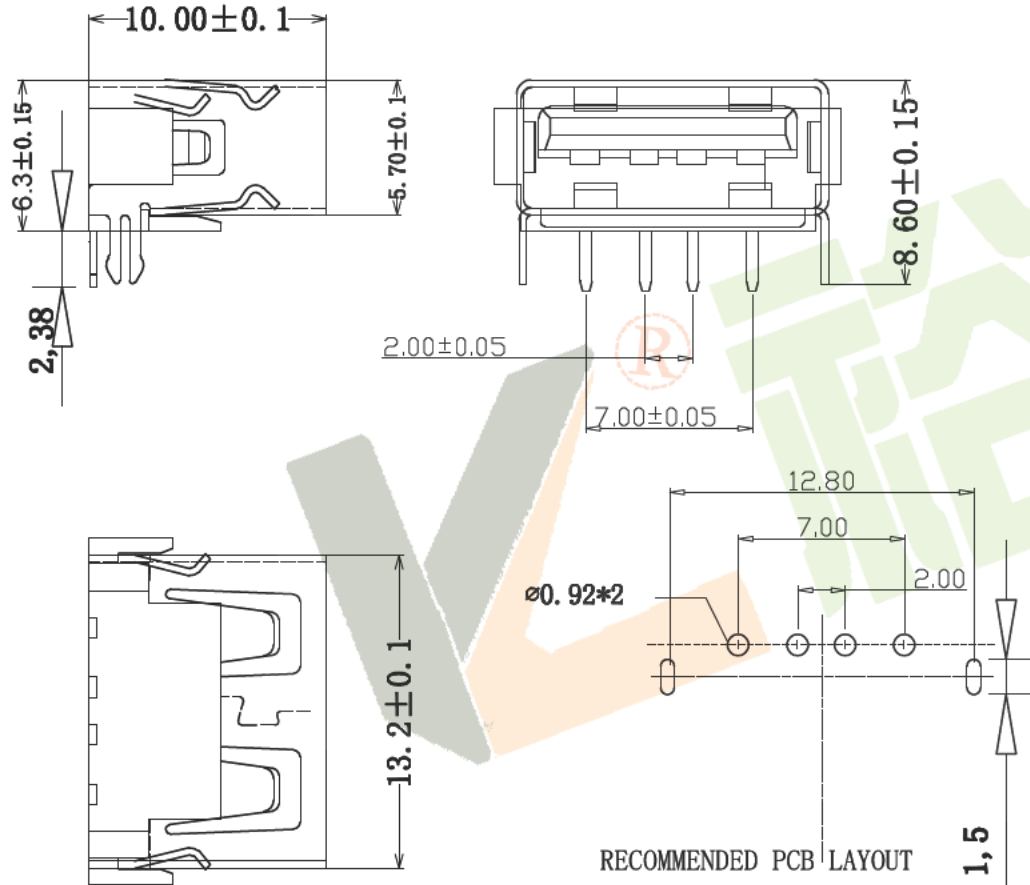


符合RoHS环保要求



NOTES:

1. MATERIAL SPECIFICATION

- 1) INSULATION MATERIAL THERMOPLASTIC.
- 2) SHELL: COPPER ALLOY/SPCC, T: 0.30mm
PLATING: NICKEL
- 3) TERMINAL: COPPER ALLOY, T: 0.25mm
PLATING: GOLD/TIN PLATED.

2. ELECTRICAL CHARACTERISTIC:

- 1) INSULATION RESISTANCE: $1000M \Omega$ MIN.
- 2) CONTACT RESISTANCE: $30m \Omega$ MAX.
- 3) WITHSTANDING VOLTAGE: 500V AC.

3. MECHANICAL CHARACTERISTICS:

- 1) INSERTION FORCE: 3.57Kgf MAX.
- 2) EXTRACTION FORCE: 1.02Kgf MIN.

ORDERING INFORMATION

A 02-D X X X X X 0 X-1063

结构流水码:

- 1060: 两个鱼叉脚1.9(有翻边)
- 1061: 两个鱼叉脚2.3(有翻边)
- 1062: 两个鱼叉脚2.3(有翻边, 端子外露2.3)
- 1063: 两个鱼叉脚1.9(无翻边)

包装方式区分码:

1: 格子盒

胶壳颜色区分码:

0: 黑色

胶壳材质区分码:

1: PBT

2: LCP

端子电镀区分码:

1: G/F 1U" 引脚亮锡

外壳电镀区分码:

1: NI $\geq 60\mu$ " 2: NI $\geq 80\mu$ "

3: NI $\geq 100\mu$ " 4: NI $\geq 150\mu$ "

外壳材质区分码:

1: Copper Alloy

2: SPCC

D: DIP

USB 2.0 F

A TYPE

RECOMMENDED PCB LAYOUT

产品图

PRODUCT CHART DWG

公差一览表

TOLERANCE UNLESS OTHERWISE

.X	± 0.15	X	$\pm 5'$
.XX	± 0.05	.X	$\pm 2'$
.XXX	± 0.02	.XX	$\pm 1'$

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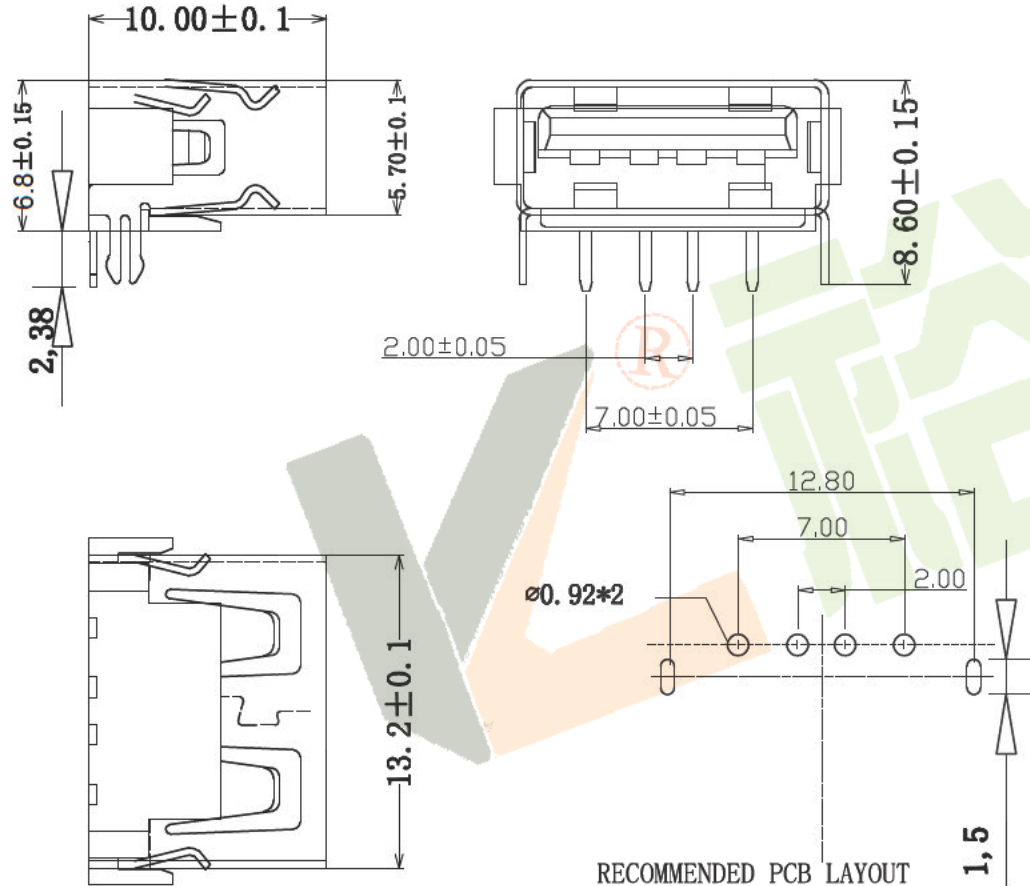
深圳市裕诚电子有限公司

SHENZHEN YUCHENG ELECTRONICS CO., LTD

单位 UNITS	MM	制图 DRAWING	陈雅	制图料号 PRODUCT PART NO	USB-90H10-63Z
比例 SCALE	1:1	审核 CHKD	洪章波	产品名称 PRODUCT NO	90度10.0直边
日期 DATE	2016.2.5	核准 APPD	魏杰	角法 VIEW	版本 VER



符合RoHS环保要求



NOTES:

1. MATERIAL SPECIFICATION

- 1) INSULATION MATERIAL THERMOPLASTIC.
- 2) SHELL: COPPER ALLOY/SPCC, T: 0.30mm
PLATING: NICKEL
- 3) TERMINAL: COPPER ALLOY, T: 0.25mm
PLATING: GOLD/TIN PLATED.

2. ELECTRICAL CHARACTERISTIC:

- 1) INSULATION RESISTANCE: 1000MΩ MIN.
- 2) CONTACT RESISTANCE: 30mΩ MAX.
- 3) WITHSTANDING VOLTAGE: 500V AC.

3. MECHANICAL CHARACTERISTICS:

- 1) INSERTION FORCE: 3.57Kgf MAX.
- 2) EXTRACTION FORCE: 1.02Kgf MIN.

ORDERING INFORMATION

A 02-D X X X X X 0 X-1063

结构流水码:

- 1060: 两个鱼叉脚1.9(有翻边)
- 1061: 两个鱼叉脚2.3(有翻边)
- 1062: 两个鱼叉脚2.3(有翻边, 端子外露2.3)
- 1063: 两个鱼叉脚1.9(无翻边)

包装方式区分码:

1: 格子盒

胶壳颜色区分码:

0: 黑色

胶壳材质区分码:

1: PBT

2: LCP

端子电镀区分码:

1: G/F 1U" 引脚亮锡

外壳电镀区分码:

1: NI ≥ 60μ" 2: NI ≥ 80μ"

3: NI ≥ 100μ" 4: NI ≥ 150μ"

外壳材质区分码:

1: Copper Alloy

2: SPCC

D: DIP

USB 2.0 F

A TYPE

RECOMMENDED PCB LAYOUT

产品图

PRODUCT CHART DWG

公差一览表

TOLERANCE UNLESS OTHERWISE			
.X	±0.15	X	±5°
.XX	±0.05	.X	±2°
.XXX	±0.02	.XX	±1°

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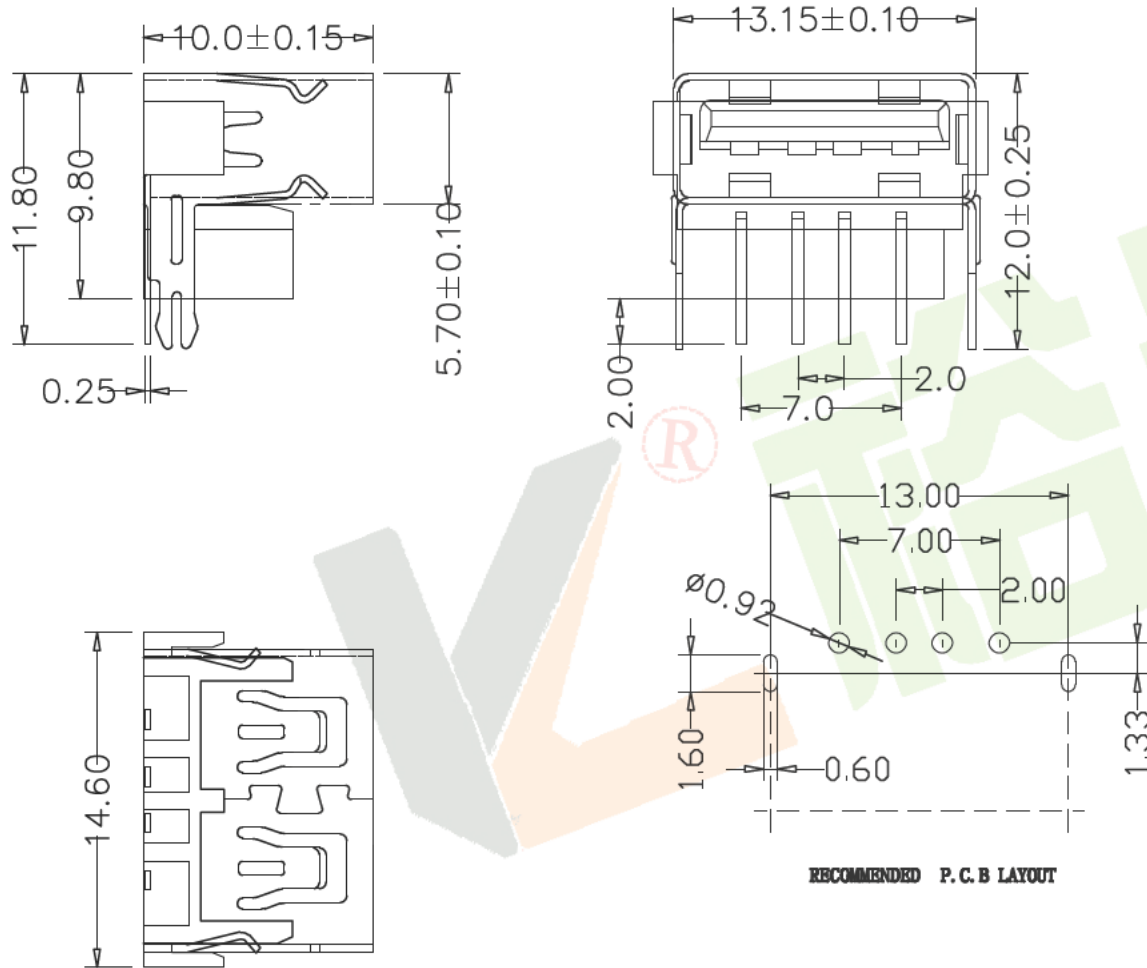


深圳市裕诚电子有限公司

SHENZHEN YUCHENG ELECTRONICS CO., LTD

单位 UNITS	MM	制图 DRAWING	陈雅	制图料号 PRODUCT PART NO	USB-90H10-68Z
比例 SCALE	1:1	审核 CHKD	洪章波	产品名称 PRODUCT NAME	90度10.0直边
日期 DATE	2016.2.5	核准 APPD	魏杰	角法 VIEW	版本 VER
					A□

符合RoHS环保要求



规格说明: Specifications:

电气特性: Electrical:

1. 额定电流: Current Rating
1.5A/contact terminal
2. 额定电压: Voltage Rating
30V DC
3. 接触电阻: Contact Resistance
30 milliohms MAX
4. 耐压: Dielectric Withstanding Voltage:
500 V AC AT Sea Level
5. 绝缘电阻: Insulation Resistance:
1000MEGA ohms MIN

物理性能: Mechanical:

1. 插拔力: Connector Mate and Unmate Force
Mate force: 3.57kgf(MAX)
Unmate force: 1.02kgf(MIN)
2. 端子保持力: Terminal Retention
1.0kgf(MIN)

原材料: Material:

1. 塑胶: Housing:
High Temperature Thermoplastics,
2. 端子: Contact: Copper Alloy C2680
3. 外壳: Shell: Copper Alloy C2680/SPCC

电镀: Finish:

1. 端子: Contact: Plated Gold in Mating Area;
Tin On Solder Tails

端子四周镀50U"(MIN)锡, 镀金区域镀100-200U"镀金1U"

2. 外壳: Shell:

铜壳四周镀80U"(MIN)锡

Nickel Plating

RECOMMENDED P.C.B LAYOUT

产品图

PRODUCT CHART DWG

公差一览表

TOLERANCE UNLESS OTHERWISE			
.X	±0.15	.X	±5'
.XX	±0.05	.X	±2'
.XXX	±0.02	.XX	±1'

www.ycelectron.com



深圳市裕诚电子有限公司

SHENZHEN YUCHENG ELECTRONICS CO., LTD

单位 UNITS	MM	制图 DRAWING	陈雅	制图料号 PRODUCT PART NO	USB-90H10-98Z
比例 SCALE	1:1	审核 CHKD	洪章波	产品名称 PRODUCT NAME	媒体直连后脚9.8(90度) 母座
日期 DATE	2016.2.5	核准 APPD	魏杰	角法 VIEW	版本 VER
					A0